



## Editorial

Welcome to this belated issue of the Journal of ISSS. The area of smart systems and structures is a rapidly growing one. These are several groups around the world working in fierce competition with each other in overlapping research interests. Needless to say, rapid publication of research results is highly desired by this community. Given this background, it is certain that eyebrows will be raised if one looks at the submission history of articles published in this issue of the Journal of ISSS. Up until 2016, the editorial and manuscript processing tasks for this journal was done on volunteer basis by members of the ISSS working in academic institutes and national laboratories. For these volunteers, these tasks bring in an extra load to their existing teaching, research and administrative duties. Much of the journal related work was relegated to lunch breaks and weekends. Delays were unavoidable in this mode of operation. It was soon realized that a more professional system was needed where much of the routine communication and follow up work could be handled by dedicated professionals using on-line tools. The Governing Council of the ISSS decided to enter into an agreement with Springer for the co-publication of the journal of the ISSS. After several rounds of meetings and discussions, a formal contract was signed with Springer and the journal was renamed “ISSS Journal of Micro and Smart Systems” (<http://www.springer.com/engineering/journal/41683>) and is now a regular member of the Springer stable. The editorial board was significantly expanded to include a large number of prominent experts in the field. The first issue of the new journal is released in 2017.

Before signing off from this final issue of the Journal of ISSS, we would like to thank all the contributing authors for their immense patience and prompt responses over the past few months that has made it possible to put this issue together. We are grateful to the reviewers for providing valuable and timely reviews of both original and revised versions of manuscripts. We are thankful to Ms. Revathy and team from M/s. Medlar India for their excellent layout and type setting services. We hope the authors will continue their association with the journal in its new and vastly improved form by contributing to the ISSS Journal of Micro and Smart Systems.

With best wishes

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